650 V, 100 A Field Stop **Trench IGBT Short Circuit Rated IGBT**

General Description

Using novel field stop IGBT technology, ON Semiconductor's new series of field stop 3rd generation IGBTs offer the optimum performance for solar, UPS, motor control, ESS and HVAC applications where low conduction and switching losses are essential.

Features

- Maximum Junction Temperature: $T_J = 175$ °C
- Positive Temperature Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)} = 1.5 \text{ V (Typ.)}$ @ $I_C = 100 \text{ A}$
- High Input Impedance
- Fast Switching
- Short Cirruit Rated 5 us
- Tighten Parameter Distribution
- These Devices are Pb-Free and are RoHS Compliant

Applications

• Solar, UPS, Motor Control, ESS, HVAC



ON Semiconductor®

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TO-247 CASE 340CD

ORDERING INFORMATION

See detailed ordering and shipping information on page 3 of this data sheet

ABSOLUTE MAXIMUM RATINGS (at $T_C = 25^{\circ}C$, Unless otherwise specified)

Symbol	Parameter	Value	Unit
V _{CES}	Collector to Emitter Voltage	650	V
V _{GES}	Gate to Emitter Voltage	±25	V
	Transient Gate to Emitter Voltage	±30	V
I _C	Collector Current @ T _C = 25°C	200	Α
	Collector Current @ T _C = 100°C	100	Α
I _{LM} (Note 1)	Clamped Inductive Load Current @ T _C = 25°C	300	Α
I _{CM} (Note 2)	Pulsed Collector Current	300	Α
I _F	Diode Forward Current @ $T_C = 25^{\circ}C$ @ $T_C = 100^{\circ}C$	200 100	A
I _{FM} (Note 2)	Pulsed Diode Maximum Forward Current	300	Α
P _D	Maximum Power Dissipation @ T _C = 25°C	750	W
	Maximum Power Dissipation @ T _C = 100°C	375	W
TJ	Operating Junction Temperature	-55 to +175	°C
T _{stg}	Storage Temperature Range	-55 to +175	°C
TL	Maximum Lead Temp. for Soldering Purposes, 1/8" from Case for 5 seconds	300	°C
T _{SC} (Note 3)	Short circuit withstanding time @ T _C = 150°C	5	μs

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. V_{CC} = 400 V, V_{GE} = 15 V, I_{C} = 375 A, R_{G} = 10 Ω , Inductive Load. 2. Repetitive rating: Pulse width limited by max. junction temperature.
- 3. Test condition: $V_{GE} = 15 \text{ V}$, $V_{CC} = 400 \text{ V}$.

THERMAL CHARACTERISTICS

Symbol	Parameter	Value	Unit	
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case, Max.	0.2	°C/W	
R _{θJC} (Diode)	Thermal Resistance, Junction to Case, Max.	0.3	°C/W	
$R_{ hetaJA}$	Thermal Resistance, Junction to Ambient, Max.	40	°C/W	

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
OFF CHARAC	TERISTICS	1		1	I.	J
BV _{CES}	Collector to Emitter Breakdown Voltage	V _{GE} = 0 V, I _C = 1 mA	650	_	_	V
$\Delta BV_{CES} / \Delta T_{J}$	Temperature Coefficient of Breakdown Voltage	I _C = 1 mA, Reference to 25°C	-	0.56	-	V/°C
I _{CES}	Collector Cut-Off Current	$V_{CE} = V_{CES}, V_{GE} = 0 V$	-	_	250	μΑ
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	_	_	±400	nA
ON CHARAC	TERISTICS			•		
V _{GE(th)}	G-E Threshold Voltage	I_C = 100 mA, V_{CE} = V_{GE}	3.5	5.3	6.9	V
V _{CE(sat)}	Collector to Emitter Saturation	I _C = 100 A, V _{GE} = 15 V	-	1.5	1.9	V
	Voltage	I _C = 100 A, V _{GE} = 15 V, T _C = 175°C	-	1.97	-	V
DYNAMIC CH	ARACTERISTICS			•		•
C _{ies}	Input Capacitance	$V_{CE} = 30 \text{ V}, V_{GE} = 0 \text{ V},$	-	6310	_	pF
C _{oes}	Output Capacitance	f = 1 MHz	-	384	-	pF
C _{res}	Reverse Transfer Capacitance		-	46	-	pF
SWITCHING (CHARACTERISTICS			•		
t _{d(on)}	Turn-On Delay Time	$V_{CC} = 400 \text{ V}, I_{C} = 100 \text{ A},$	-	84	_	ns
t _r	Rise Time	$R_G = 4.7 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 25^{\circ}C$	-	147	-	ns
t _{d(off)}	Turn-Off Delay Time		_	216	-	ns
t _f	Fall Time		_	133	-	ns
E _{on}	Turn-On Switching Loss		_	5.4	-	mJ
E _{off}	Turn-Off Switching Loss		_	3.8	-	mJ
E _{ts}	Total Switching Loss		_	9.2	-	mJ
t _{d(on)}	Turn-On Delay Time	$V_{CC} = 400 \text{ V}, I_{C} = 100 \text{ A},$	_	80	-	ns
t _r	Rise Time	$R_G = 4.7 \Omega$, $V_{GE} = 15 V$, Inductive Load, $T_C = 175^{\circ}C$	_	160	-	ns
t _{d(off)}	Turn-Off Delay Time		_	244	-	ns
t _f	Fall Time		_	166	-	ns
E _{on}	Turn-On Switching Loss		-	9.7	-	mJ
E _{off}	Turn-Off Switching Loss		-	5.2	_	mJ
E _{ts}	Total Switching Loss		-	14.9	_	mJ
Qg	Total Gate Charge	V _{CE} = 400 V, I _C = 100 A,	-	157	_	nC
Q _{ge}	Gate to Emitter Charge	V _{GE} = 15 V	-	43	-	nC
Q _{gc}	Gate to Collector Charge		_	46	-	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ELECTRICAL CHARACTERISTICS OF THE DIODE ($T_C = 25^{\circ}C$ unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
V _{FM}	Diode Forward Voltage	I _F = 100 A T _C = 25°C T _C = 175°C	_ _	1.68 1.45	2.1	V
E _{rec}	Reverse Recovery Energy	$I_F = 100 \text{ A, } dI_F/dt = 200 \text{ A/}\mu\text{s,}$ $T_C = 175^{\circ}\text{C}$	_	96	-	μJ
t _{rr}	Diode Reverse Recovery Time	$I_F = 100 \text{ A}, dI_F/dt = 200 \text{ A}/\mu\text{s}$ $T_C = 25^{\circ}\text{C}$ $T_C = 175^{\circ}\text{C}$	_ _	62 251	-	ns
Q _{rr}	Diode Reverse Recovery Charge	$I_F = 100 \text{ A}, dI_F/dt = 200 \text{ A}/\mu\text{s}$ $T_C = 25^{\circ}\text{C}$ $T_C = 175^{\circ}\text{C}$	_ _	164 2736	- -	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

PACKAGE MARKING AND ORDERING INFORMATION

Pare	Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FGY10	00T65SCDT	FGY100T65SCDT	TO-247H03	Tube	_	_	30

TYPICAL PERFORMANCE CHARACTERISTICS

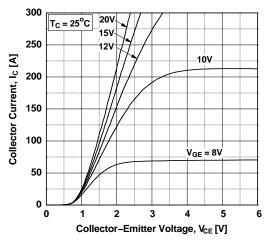


Figure 1. Typical Output Characteristics

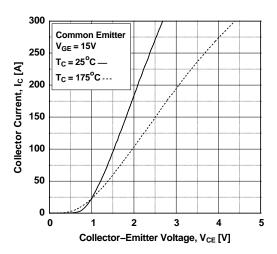


Figure 3. Typical Saturation Voltage Characteristics

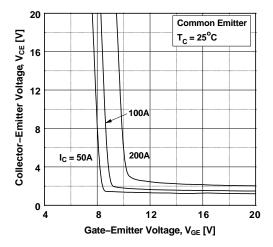


Figure 5. Saturation Voltage vs. V_{GE}

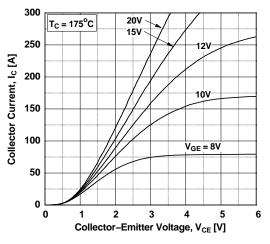


Figure 2. Typical Output Characteristics

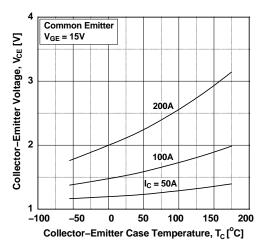


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level

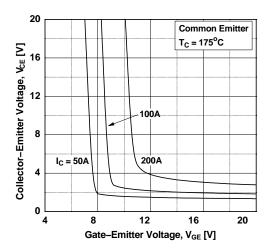


Figure 6. Saturation Voltage vs. V_{GE}

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

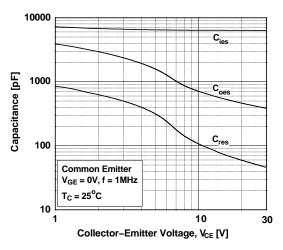


Figure 7. Capacitance Characteristics

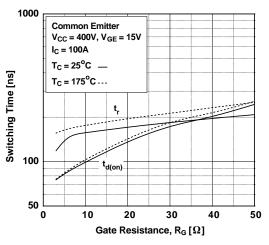


Figure 9. Turn-on Characteristics vs. Gate Resistance

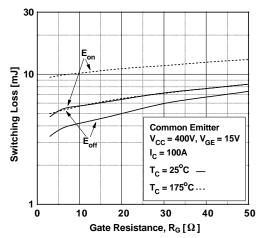


Figure 11. Switching Loss vs. Gate Resistance

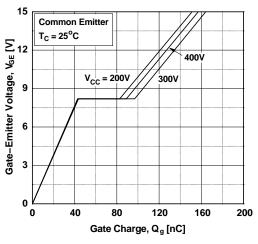


Figure 8. Gate Charge Characteristics

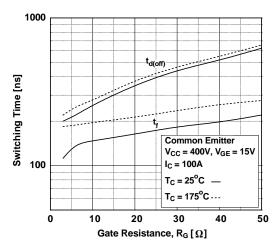


Figure 10. Turn-off Characteristics vs. Gate Resistance

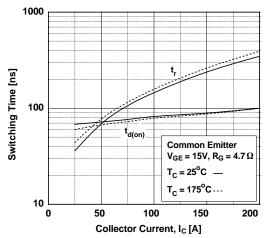


Figure 12. Turn-on Characteristics vs. Collector Current

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

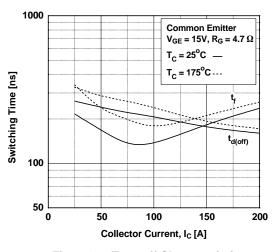


Figure 13. Turn-off Characteristics vs.
Collector Current

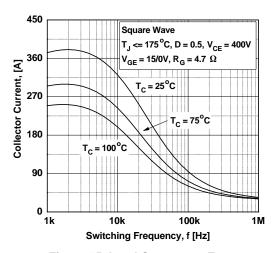


Figure 15. Load Current vs. Frequency

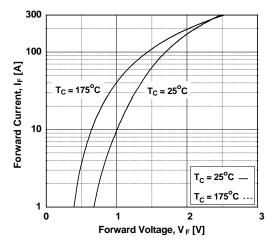


Figure 17. Forward Characteristics

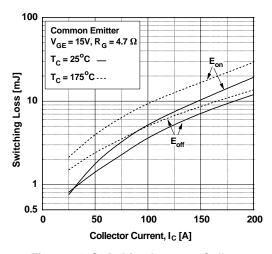


Figure 14. Switching Loss vs. Collector Current

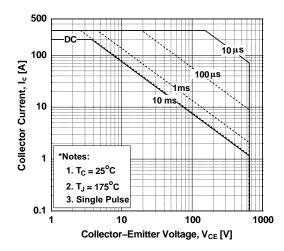


Figure 16. SOA Characteristics

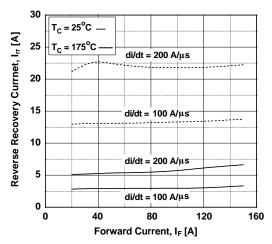


Figure 18. Reverse Recovery Current

TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

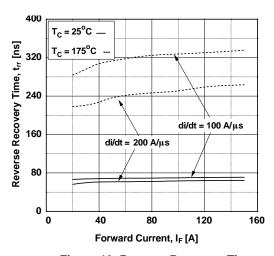


Figure 19. Reverse Recovery Time

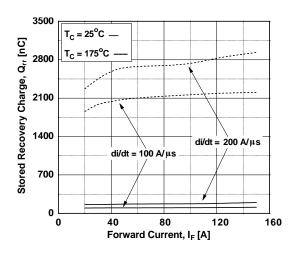


Figure 20. Stored Charge

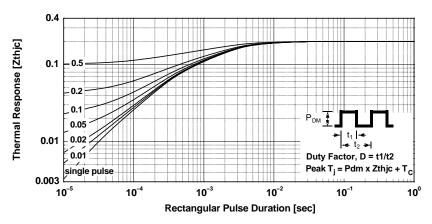


Figure 21. Transient Thermal Impedance of IGBT

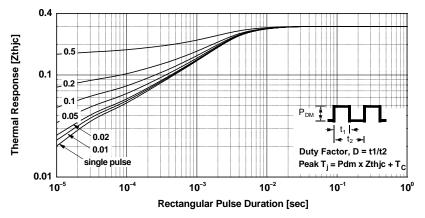
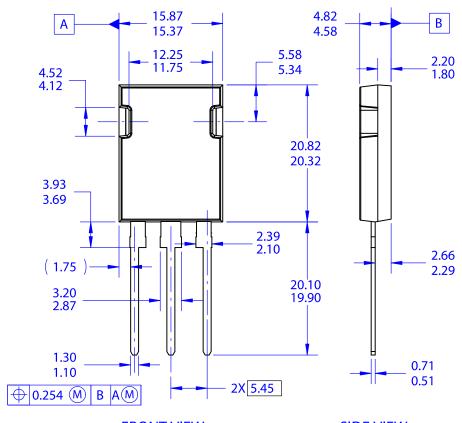
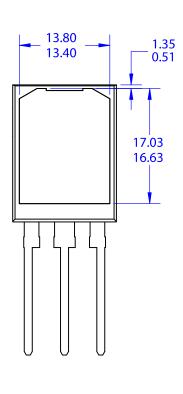


Figure 22. Transient Thermal Impedance of Diode

PACKAGE DIMENSIONS

TO-247-3LD CASE 340CD ISSUE O





FRONT VIEW SIDE VIEW BOTTOM VIEW

NOTES:

A. THIS PACKAGE DOES NOT CONFORM TO ANY STANDARDS.

B. ALL DIMENSIONS ARE IN MILLIMETERS.

C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH AND TIE BAR PROTRUSIONS.

D. DIMENSION AND TOLERANCE AS PER ASME Y14.5-2009.

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